

STHDLS101T

AC coupled HDMI level shifter with configurable HPD output

Features

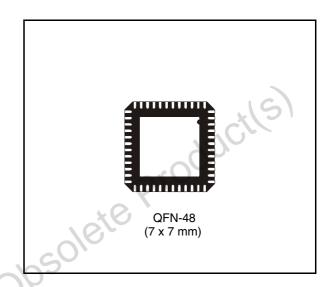
- Converts low-swing alternating current (AC) coupled differential input to high-definition multimedia interface (HDMI) rev 1.3 compliant
- HDMI level shifting operation up to 2.7 Gbps per lane
- Integrated 50-Ω termination resistors for ACcoupled differential inputs
- Input/output transition minimized differential signaling (TMDS) enable/disable
- Output slew rate control on TMDS outputs to minimize electromagnetic interference (EMI)
- Fail safe outputs for backdrive protection
- No re-timing or configuration required
- Inter-pair output skew < 250 ps</p>
- Intra-pair output skew < 10 ps</p>
- Single power supply of 3.3 V
- ESD protection: ±6 KV HBM on all I/O pins
- Integrated display data channel (DDC) level shifters. Pass-gate voltage limiters allow 3.3 V termination on graphics and memory controller hub (GMCH) pins and 5 V DDC termination on HDMI connector pins
- Level shifter and configurable output for HPD signal from HDMI/DVI connector
- Integrated pull-down resistor on HPD_SINK and OE_N inputs

Applications

- Notebooks
- PC motherboards and graphic cards
- Dongles/cable adapters

Table 1. Device summary

Table 1. Device Sammary		
Order code	Package	Packaging
STHDLS101TQTR	QFN-48	Tape and reel



Description

The STHDLS101T is a high-speed high-definition multimedia interface (HDMI) level shifter that converts low-swing AC coupled differential input to HDMI 1.3 compliant open-drain current steering RX-terminated differential output. Through the existing PCI-E pins in the graphics and memory controller hub (GMCH) of PCs or notebook motherboards, the pixel clock provides the required bandwidth (1.65 Gbps, 2.25 Gbps) for the video supporting 720p, 1080i, 1080p with a total of 36-bit resolution. The HDMI is multiplexed onto the PCIe pins in the motherboard where the AC coupled HDMI at 1.2 V is output by GMCH. The AC coupled HDMI is then level shifter by this device to 3.3 V DC coupled HDMI output.

The STHDLS101T supports up to 2.7 Gbps, which is enough for 12-bits of color depth per channel, as indicated in HDMI rev 1.3. The device operates from a single 3.3 V supply and is available in a 48-pin QFN package.

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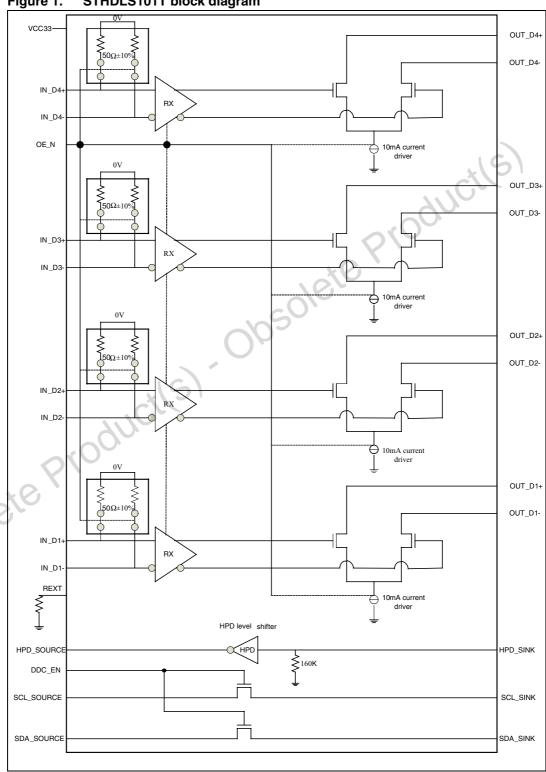
STHDLS101T Contents

Obsolete Product(s). Obsolete Product(s)

Block diagram STHDLS101T

Block diagram 1





STHDLS101T **System interface**

System interface 2

Figure 2. System inferface

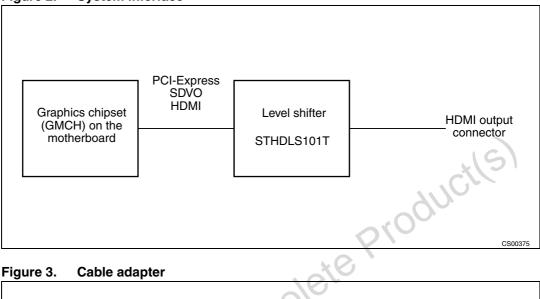
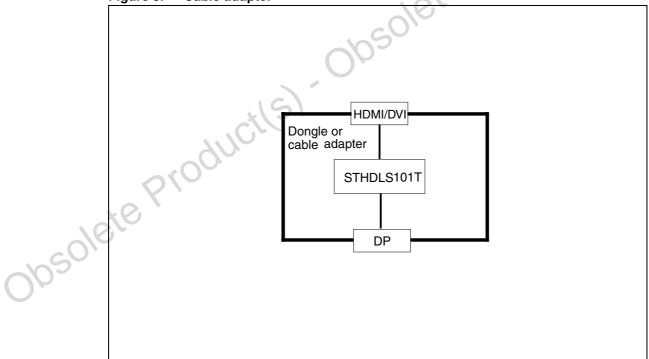


Figure 3. Cable adapter



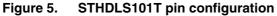
System interface STHDLS101T

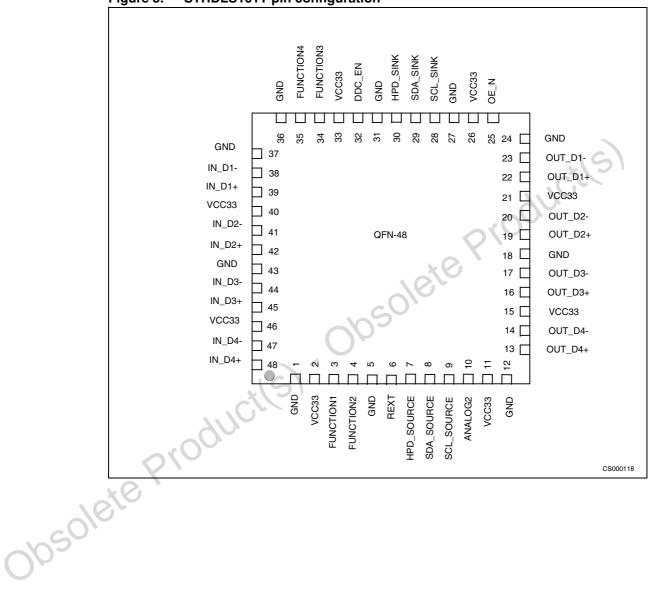
HDMI/DVI Connector HPD_SINK HPD_SOURCE HDMI/DVI DC TMDS STHDLS101T HDMI/DVI Cable AC_TMDS AC_TMDS DDC Adaptor DDC DDC Ы Obsolete Products). Obsolete Products). AM00761V1

Figure 4. DP to HDMI/DVI cable adapter

STHDLS101T Pin configuration

3 Pin configuration





Pin configuration STHDLS101T

3.1 Pin description

Table 2. Pin description

	Pin	Pin descrip					
	number	Name	Туре		Function		
	1	GND	Power	Ground			
	2	VCC33	Power	3.3V±10% DC supp	oly		
	3	FUNCTION1	Vendor-specific control or test pins	Function pins are to test modes. For normal operation VCC33. For consistent interdefault connection for the second	on, these pins are	e tied to GND or	
	4	FUNCTION2	Vendor-specific control or test pins	Function pins are to test modes. For normal operation VCC33. For consistent inter- default connection to	on, these pins are	e tied to GND or	
	5	GND	Power	Ground			
	6	REXT	Analog	Connection to external resistor. Resistor value specified by device manufacturer. Acceptable connections to this pin are: - Resistor to GND - Resistor to 3.3V; - NC (direct connections to V _{CC} or GND are throug 0-Ù resistor for layout compatibility			
	7	HPD_SOURCE	Output	Buffer from the 0 V buffer stage is confi pin settings as desr	igurable based o	n the FUNCTION3	
	x (2)			FUNCTION3	HPD_SINK	HPD_SOURCE	
Obsole				0	Low	Open-drain, connected an external pull up to the desired supply (normally 1 V)	
				0	High (5 V)	Low (0 V)	
				1	Low (0 V)	Low (0 V)	
				1	High (5 V)	High (3 V)	
	8	SDA_SOURCE	I/O	3.3 V DDC data I/O to 3.3 V. Connected limiting integrated N	to SDA_SINK th		
	9	SCL_SOURCE	Input	3.3 V DDC clock I/O. Pulled-up by external termination to 3.3 V. Connected to SCL_SINK through voltage-limiting integrated NMOS pass-gate			

STHDLS101T Pin configuration

Table 2. Pin description (continued)

Pin number Name Type Function		Table 2.	2. Pin description (continued)				
Analog Analog Analog Acceptable connections to this pin are: - Resistor or capacitor to GND - Rosistor or capacitor to 3.3 V - Short to 3.3 V or to GND - Rosistor or capacitor to 3.3 V - Short to 3.3 V or to GND - NC 11 VCC33 Power Ground 13 OUT_D4+ Output HDMI 1.3 compliant TMDS output. OUT_D4+ makes a differential output signal with OUT_D4- 14 OUT_D4- Output OUT_D4+ MBMI 1.3 compliant TMDS output. OUT_D4+ makes a differential output signal with OUT_D4+. 15 VCC33 Power 3.3 V±10% DC supply HDMI 1.3 compliant TMDS output. OUT_D3+ makes a differential output signal with OUT_D3- 17 OUT_D3- Output OUT_D3- makes a differential output signal with OUT_D3- 18 GND Power Ground 19 OUT_D2+ Output OUT_D2+ makes a differential output signal with OUT_D2 20 OUT_D2- Output OUT_D2- makes a differential output signal with OUT_D2- 21 VCC33 Power 3.3 V±10% DC supply HDMI 1.3 compliant TMDS output. OUT_D2- makes a differential output signal with OUT_D2 21 VCC33 Power 3.3 V±10% DC supply HDMI 1.3 compliant TMDS output. OUT_D2- makes a differential output signal with OUT_D2 21 VCC33 Power 3.3 V±10% DC supply HDMI 1.3 compliant TMDS output. OUT_D1+ makes a differential output signal with OUT_D1 23 OUT_D1- Output HDMI 1.3 compliant TMDS output. OUT_D1- makes a differential output signal with OUT_D1 24 GND Power Ground Enable for level shifter path. 3.3 V tolerant low-voltage			Name	Туре		Function	
12 GND Power Ground HDMI 1.3 compliant TMDS output. OUT_D4+ makes a differential output signal with OUT_D4 14 OUT_D4- Output OUT_D4- makes a differential output signal with OUT_D4- makes a differential output signal with OUT_D4+. 15 VCC33 Power 3.3 V±10% DC supply HDMI 1.3 compliant TMDS output. OUT_D3+ makes a differential output signal with OUT_D3+ makes a differential output signal with OUT_D3- makes a differential output signal with OUT_D3- makes a differential output signal with OUT_D3+ makes a differential output signal with OUT_D3+ makes a differential output signal with OUT_D2+ makes a differential output signal with OUT_D2- makes a differential output signal with OUT_D2+ makes a differential output signal with OUT_D2- makes a differential output signal with OUT_D2- makes a differential output signal with OUT_D2- makes a differential output signal with OUT_D1- makes a differential output signal with OUT_D1- MDMI 1.3 compliant TMDS output. OUT_D1- makes a differential output signal with OUT_D1- MDMI 1.3 compliant TMDS output. OUT_D1- makes a differential output signal with OUT_D1- MDMI 1.3 compliant TMDS output. OUT_D1- makes a differential output signal with OUT_D1- MDMI 1.3 compliant TMDS output. OUT_D1- makes a differential output signal with OUT_D1- MDMI 1.3 compliant TMDS output. OUT_D1- makes a differential output signal with OUT_D1- MDMI 1.3 compliant TMDS output. OUT_D1- makes a differential output signal with OUT_D1- makes a		10	ANALOG2	Analog	Acceptable connec - Resistor or capac - Resistor or capac - Short to 3.3 V or t	tions to this pin a itor to GND itor to 3.3 V	
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13 OUT_D4+ Output OUT_D4+ makes a differential output signal with OUT_D4 14 OUT_D4- Output OUT_D4- makes a differential output signal with OUT_D4- makes a differential output signal with OUT_D4+. 15 VCC33 Power 3.3 V±10% DC supply HDMI 1.3 compliant TMDS output. OUT_D3+ makes a differential output signal with OUT_D3+ makes a differential output signal with OUT_D3- MDMI 1.3 compliant TMDS output. OUT_D3- makes a differential output signal with OUT_D3- makes a differential output signal with OUT_D3+ makes a differential output signal with OUT_D2+ makes a differential output signal with OUT_D2- makes a differential output signal with OUT_D1- Output MDMI 1.3 compliant TMDS output. OUT_D2- makes a differential output signal with OUT_D1- Output HDMI 1.3 compliant TMDS output. OUT_D1- makes a differential output signal with OUT_D1- MDMI 1.3 compliant TMDS output. OUT_D1- makes a differential output signal with OUT_D1- MDMI 1.3 compliant TMDS output. OUT_D1- makes a differential output signal with OUT_D1- MDMI 1.3 compliant TMDS output. OUT_D1- makes a differential output signal with OUT_D1- makes a differential output signal with OUT_D1- MDMI 0.3 compliant TMDS output. OUT_D1- makes a differential output signal with OUT_D1- MDMI 0.3 compliant TMDS output. OUT_D1- makes a differential output signal with OUT_D1- MDMI 0.3 compliant TMDS output. OUT_D1- makes a differential output signal with OUT_D1- MDMI 0.3 compliant TMDS output.		12	GND	Power	Ground		
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16 OUT_D3+ Output OUT_D3+ makes a differential output signal with OUT_D3- makes a differential output signal with OUT_D3- Output OUT_D3- makes a differential output signal with OUT_D3+ makes a differential output signal with OUT_D3+. 18 GND Power Ground 19 OUT_D2+ Output OUT_D2+ makes a differential output signal with OUT_D2 20 OUT_D2- Output OUT_D2- makes a differential output signal with OUT_D2 21 VCC33 Power 3.3 V±10% DC supply 22 OUT_D1+ Output HDMI 1.3 compliant TMDS output. OUT_D1+ makes a differential output signal with OUT_D1 23 OUT_D1- Output HDMI 1.3 compliant TMDS output. OUT_D1- makes a differential output signal with OUT_D1 24 GND Power Ground Enable for level shifter path. 3.3 V tolerant low-voltage		14	OUT_D4-	Output	OUT_D4- makes a		It signal with
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17 OUT_D3- Output OUT_D3- makes a differential output signal with OUT_D3+. 18 GND Power Ground 19 OUT_D2+ Output OUT_D2+ makes a differential output signal with OUT_D2- makes a differential output signal with OUT_D2- Output OUT_D2- makes a differential output signal with OUT_D2+ makes a differential output signal with OUT_D2+ makes a differential output signal with OUT_D2+. 21 VCC33 Power 3.3 V±10% DC supply 22 OUT_D1+ Output HDMI 1.3 compliant TMDS output. OUT_D1+ makes a differential output signal with OUT_D1 23 OUT_D1- Output HDMI 1.3 compliant TMDS output. OUT_D1- makes a differential output signal with OUT_D1 44 GND Power Ground Enable for level shifter path. 3.3 V tolerant low-voltage		16	OUT_D3+	Output	OUT_D3+ makes a differential output signal with		
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19 OUT_D2+ Output OUT_D2+ makes a differential output signal with OUT_D2 20 OUT_D2- Output HDMI 1.3 compliant TMDS output. 21 VCC33 Power 3.3 V±10% DC supply 22 OUT_D1+ Output HDMI 1.3 compliant TMDS output. OUT_D1+ makes a differential output signal with OUT_D1 23 OUT_D1- Output HDMI 1.3 compliant TMDS output. OUT_D1- makes a differential output signal with OUT_D1 24 GND Power Ground Enable for level shifter path. 3.3 V tolerant low-voltage		18	GND	Power	Ground		
20 OUT_D2- Output OUT_D2- makes a differential output signal with OUT_D2+. 21 VCC33 Power 3.3 V±10% DC supply 22 OUT_D1+ Output HDMI 1.3 compliant TMDS output. OUT_D1+ makes a differential output signal with OUT_D1 23 OUT_D1- Output HDMI 1.3 compliant TMDS output. OUT_D1- makes a differential output signal with OUT_D1- makes a differential output signal with OUT_D1+. 24 GND Power Ground Enable for level shifter path. 3.3 V tolerant low-voltage		19	OUT_D2+	Output	OUT_D2+ makes a		ut signal with
22 OUT_D1+ Output HDMI 1.3 compliant TMDS output. OUT_D1+ makes a differential output signal with OUT_D1 23 OUT_D1- Output HDMI 1.3 compliant TMDS output. OUT_D1- makes a differential output signal with OUT_D1+. 24 GND Power Ground Enable for level shifter path. 3.3 V tolerant low-voltage		20	OUT_D2-	Output	OUT_D2- makes a differential output signal with		
23 OUT_D1- Output differential output signal with OUT_D1 23 OUT_D1- Output HDMI 1.3 compliant TMDS output. OUT_D1- makes a differential output signal with OUT_D1+. 24 GND Power Ground Enable for level shifter path. 3.3 V tolerant low-voltage	16	21	VCC33	Power	3.3 V±10% DC sup	ply	
23 OUT_DT- Output differential output signal with OUT_D1+. 24 GND Power Ground Enable for level shifter path. 3.3 V tolerant low-voltage	00501	22	OUT_D1+	Output	•	•	
Enable for level shifter path. 3.3 V tolerant low-voltage	Ob	23	OUT_D1-	Output	•	•	
		24	GND	Power	Ground		
when unconnected.					single-ended input.	Internal pull-dow	
25 OE_N Input OE_N IN_D termination OUT_D Outputs		25	OE_N	Input	OE_N		OUT_D Outputs
1 High-Z High-Z					1	High-Z	High-Z
0 50Ω Active					0	50 Ω	Active
26 VCC33 Power 3.3 V±10% DC supply				_			•

Pin configuration STHDLS101T

Table 2. Pin description (continued)

	Table 2.	Pin description (continued)				
	Pin number	Name	Туре		Function	
	27	GND	Power	Ground		
	28	SCL_SINK	Output		Pulled-up by external termination o SCL_SOURCE through voltage-	
	29	SDA_SINK	I/O		Pulled-up by external termination to DA_SOURCE through voltage-	
	30	HPD_SINK	Input	signal comes from tindicates "plugged"	to 5V (nominal) input signal. This the HDMI connector. Voltage high state; voltage low indicates HPD_SINK is pulled down by an oull-down resistor.	
	31	GND	Power	Ground	100,0	
				Enables bias voltage to the DDC pass-gate legates. (May be implemented as a bias voltage connection to the DDC pass-gate themselve		
	32	DDC_EN	Input	DDC_EN	Pass-gate	
				0 V	Disabled	
				3.3 V	Enabled	
	33	VCC33	Power	3.3V±10% DC supply		
	34	FUNCTION3	Input	When L, the HPD_S	ontrol of the HPD_SOURCE output. SOURCE is an open-drain output HPD_SOURCE is a buffered output	
c0/8	35	FUNCTION4	Vendor-specific control or test pins	Function pins are to enable vendor-specific feature test modes. For normal operation, these pins are tied to GND ov VCC33. For consistent interoperability, GND is the preferred default connection for these signals		
5	36	GND	Power	Ground		
	37	GND	Power	Ground		
	38	IN_D1-	Input		ial input from GMCH PCIE outputs. ferential pair with IN_D1+.	
	39	IN_D1+	Input		ial input from GMCH PCIE outputs. fferential pair with IN_D1	
	40	VCC33	Power	3.3 V±10% DC sup	ply	
	41	IN_D2-	Input		ial input from GMCH PCIE outputs. ferential pair with IN_D2+.	
	42	IN_D2+	Input		ial input from GMCH PCIE outputs. fferential pair with IN_D2	

STHDLS101T Pin configuration

Table 2. Pin description (continued)

	Pin number	Name	Туре	Function
	43	GND	Power	Ground
	44	IN_D3-	Input	Low-swing differential input from GMCH PCIE outputs. IN_D3- makes a differential pair with IN_D3+.
	45	IN_D3+	Input	Low-swing differential input from GMCH PCIE outputs. IN_D3+ makes a differential pair with IN_D3
	46	VCC33	Power	3.3 V±10% DC supply
	47	IN_D4-	Input	Low-swing differential input from GMCH PCIE outputs. IN_D4- makes a differential pair with IN_D4+.
	48	IN_D4+	Input	Low-swing differential input from GMCH PCIE outputs. IN_D4+ makes a differential pair with IN_D4
Obsole	ite P	roduci	(5)	IN_D4+ makes a differential pair with IN_D4

4 Functional description

The section describes the basic functionality of the STHDLS101T device.

Power supply

The STHDLS101T is powered by a single DC power supply of 3.3 V \pm 10%.

Clocking

This device does not retime any data. The device contains no state machines. No inputs or outputs of the device are latched or clocked.

Reset

This device acts as a level shifter, reset is not required.

OE_N function

When OE_N is asserted (low level), the IN_D and OUT_D signals are fully functional. Input termina-tion resistors are enabled and any internal bias circuits are turned on.

OE_N pin has an internal pull-down that enables the chip if left unconnected.

When OE_N is de-asserted (high level), the OUT_D outputs are in high impedance state. The IN_D input buffers are disabled and the IN_D termination resistors are disabled. Internal bias circuits for the differential inputs and outputs are turned off. Power consumption of the chip is minimized.

The HPD_SINK input and HPD_SOURCE output are not affected by OE_N. The SCL and SDA pass-gates are not affected by OE_N.

Table 3. OE N description

	OE_N	Device state	Comments
10	Asserted (low level) or unconnected	Differential input buffers and output buffers enabled. Input impedance = 50Ù	Normal functioning state for IN_D to OUT_D level shifting function.
-10501		Low-power state.	Intended for lowest power condition when:
Oh		Differential input buffers and terminations are disabled. Differential input buffers are in high-impedance state.	 No display is plugged in or The level shifted data path is disabled
	De-asserted (high level)	OUT_D level shifting outputs are disabled. OUT_D level shifting outputs are in a high-impedance	HPD_SINK input and HPD_SOURCE output are not affected by OE_N.
		state. Internal bias currents are turned off.	SCL_SOURCE, SCL_SINK, SDA_SOURCE and SDA_SINK signals and functions are not affected by OE_N.

Table 4. OE N function

	OE_N	IN_Dx	OUT_Dx (TMDS outputs)	Notes
	De-asserted (high level)	High-Z	High-Z	Device disabled. Low power state. Internal bias currents are disabled.
	Asserted or unconnected (low level)	50 Ω termination	Enabled	Level shifting mode enabled.
Opsole	ite Produc	50 Ω termination	oletePi	oduct(s)

Maximum ratings STHDLS101T

5 Maximum ratings

Stressing the device above the rating listed in the "Absolute maximum ratings" table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Exposure to Absolute maximum rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

Table 5. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage to ground potential	-0.5 to +4.0	CV
VI	DC input voltage (TMDS and PCIe ports)	-0.5 to +4.0	V
	Control pins	-0.5 to +4.0	V
	SDA_SINK, SCL_SINK, HPD_SINK pins	-0.5 to +6	V
Io	DC output current	120	mA
P _D	Power dissipation	1	W
T _{STG}	Storage temperature	-65 to +150	°C
TL	Lead temperature (10 sec)	300	°C
V _{ESD}	Electrostatic discharge voltage on IOs ⁽¹⁾ Human body model	±6	kV

^{1.} In accordance with the MIL standard 883 method 3015

Table 6. Thermal data

	Symbol	Parameter	QFN-48	Unit
	θ_{JA}	Junction-ambient thermal coefficient	48	°C/W
Obsole	ie,			

STHDLS101T **Maximum ratings**

Recommended operating conditions 5.1

5.1.1 Power supply and temperature range

Table 7. Power supply and temperature range

Symbol	Parameter	Comments	Min	Тур	Max	Unit
V _{CC33}	3.3 V power supply		3.0	3.3	3.6	V
I _{CC}	Maximum power supply current	Total current from V _{CC} 3.3 V power supply			100	mA
Т	Operating temperature range		-40		85	°C

Differential inputs (IN_D signals) 5.1.2

Table 8. Differential input characteristics for IN_D signals

Т	Operating temperature range		-40		85		°C		
5.1.2	1,10								
Symbol	Table 8. Differential input characteristics for IN_D signals Symbol Parameter Comments Min Typ Max Uni								
Tbit	Unit interval	Tbit is determined by the display mode. Nominal bit rate ranges from 250 Mbps to 2.5 Gbps per lane. Nominal Tbit at 2.5 Gbps = 400 ps. 360 ps = 400 ps - 10%	36	0			ps		
V _{RX-DIFFp-p}	Differential input peak to peak voltage	V _{RX-DIFFp-p} =2*IV _{RX-D+} - V _{RX} _{D-} I. Applies to IN_D signals.	0.17	75	1	1.2	V		
T _{RX-EYE}	Minimum eye width at IN_D input pair	The level shifter may add a maximum of 0.02UI jitter	0.8	3			Tbit		
V _{CM-AC-pp}	AC peak common mode input voltage	VCM-AC-pp=IVRX-D+ + VRX-D-I/2 - VRX-CM-DC. VRX-CM-DC=DC(avg) of IVRX-D+ + VRX-D-I/2 VCM-AC-pp includes all frequencies above 30 kHz.			1	00	mV		
Z _{RX-DC}	DC single-ended input impedance	Applies to IN_D+ as well as IN_D- pins (50 Ω ± 20% tolerance)	40) 5	0	60	Ω		
V _{RX-Bias}	RX input termination voltage	Intended to limit power-up stress on chipset's PCIE output buffers	0			2	V		
Z _{RX-HIGH-Z}	Single-ended input resistance for IN_Dx when inputs are in high-Z state	Differential inputs must be in a high impedance state	10	0			ΚΩ		

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5.2 TMDS outputs (OUT_D signals)

The level shifter's TMDS outputs are required to meet the HDMI 1.3 specifications. The HDMI 1.3 specification is assumed to be the correct reference in instances where this document conflicts with the HDMI 1.3 specification.

Table 9. Differential output characteristics for TMDS OUT_D signals

Symbol	Parameter	Comments	Min	Тур	Max	Unit
V _H	Single-ended high level output voltage	AV _{CC} is the DC termination voltage in the HDMI or DVI sink. AV _{CC} is nominally 3.3 V	AV _{CC} -10 mV	AV _{CC}	AV _{CC} +10 m V	V
V _L	Single-ended low level output voltage	The open-drain output pulls down form AV _{CC}	AV _{CC} - 600 mV	AV _{CC} - 500 mV	AV _{CC} - 400 mV	V
V _{SWING}	Single-ended output swing voltage	Swing down from TMDS termination voltage (3.3 V ±10%)	400 mV	500 mV	600 mV	V
I _{OFF}	Single-ended current in high-Z state	Measured with TMDS outputs pulled up to AV_{CC} max (3.6 V) through 50 Ω resistors	*6	blo	10	μΑ
T _R	Rise time	Maximum rise/fall time at 2.7 Gbps = 148ps. 125ps = 148 - 15%	125 ps		0.4 Tbit	ps
T _F	Fall time	Maximum rise/fall time at 2.7 Gbps = 148 ps. 125ps = 148 - 15%	125 ps		0.4 Tbit	ps
T _{SKEW} -	Intra-pair differential skew	This differential skew budget is in addition to the skew presented between D+ and D-paired input pins.			10	ps
T _{SKEW} -	Inter-pair lane to lane output skew	This lane to lane skew budget is in addition to the skew between differential input pairs.			250	ps
OT JIT	Jitter added to TMDS signals	Jitter budget for TMDS signals as they pass through the level shifter. 7.4 ps = 0.02 Tbit at 2.7 Gbps			7.4	ps

STHDLS101T Maximum ratings

5.3 HPD input and output characteristics

Table 10. HPD_SINK input and HPS_SOURCE output

Symbol	Parameter	Comment	Min	Тур	Max	Unit
V _{IH-HPD_SINK}	HPD_SINK input high level	Low speed input changes state on cable plug/unplug	2	5.0	5.3	V
V _{IL-HPD_SINK}	HPD_SINK input low level		0		0.8	V
I _{IN-HPD_SINK}	HPD_SINK input leakage current	Measured with HPD_SINK at V _{IH-HPD} max and V _{IL-HPD} min			50	μΑ
V _{OH} - HPD_SOURCE (INV)	HPD_SOURCE output high level when FUNCTION3 = L	V _{CC} = 3.3 V ±10% Based on external pull-up resistor; output is open drain.		AU	Cili	5)
V _{OL} - HPD_SOURCE	HPD_SOURCE output low level when FUNCTION3 = H	V _{CC} = 3.3 V ±10%	2.5	20,	V _{CC}	V
V _{OH} - HPD_SOURCE (INV)	HPD_SOURCE output high level when FUNCTION3 = L	$V_{CC} = 3.3 \text{ V} \pm 10\%$ $I_{OL} = 1 \text{ mA}$	0		0.2	V
$V_{OL ext{-}}$ HPD_SOURCE	HPD_SOURCE output low level when FUNCTION3 = H	$V_{CC} = 3.3 \text{ V} \pm 10\%$	0		0.2	V
T _{HPD}	HPD_SINK to HPD_SOURCE propagation delay	Time from HPD_SINK changing state to HPD_SOURCE changing state. Includes HPD_SOURCE rise/fall time C _L =10 pF			200	ns
T _{RF-HPD}	HPD_SOURCE rise/fall time	Time required to transition from V _{OH-HPD_SOURCE} to V _{OL-HPD_SOURCE} or from V _{OL-HPD_SOURCE} to V _{OH-HPD_SOURCE} C _L =10 pF	1		20	ns

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5.4 DDC input and output chatacteristics

Table 11. SDA_SOURCE, SCL_SOURCE and SDA_SINK, SCL_SINK characteristics

Symb ol	Parameter	Comment	Min	Тур	Max	Unit
VI	Input voltage on SDA_SINK, SCL_SINK pins	Voltage on the DDC pins on connector end	0		5.5	V
I _{LKG}	Input leakage current on SDA_SINK, SCL_SINK pins	V_{CC} = 3.3 V V_{I} =0.1 V_{DD} to 0.9 V_{DD} to isolated DDC inputs V_{DD} = external pull-up resistor voltage on SDA_SINK and SCL_SINK inputs (maximum of 5.5 V)	-10		10	μΑ
I _{OFF}	Power-down leakage current on SDA_SINK, SCL_SINK pins	$\begin{split} &V_{CC} = 0.0 \text{ V} \\ &V_I = 0.1 \text{ V}_{DD} \text{ to } 0.9 \text{ V}_{DD} \text{ to} \\ &DDC \text{ sink inputs} \\ &V_{DD} = \text{external pull-up} \\ &\text{resistor voltage on} \\ &SDA_SINK \text{ and SCL_SINK} \\ &\text{inputs (maximum of } 5.5 \text{ V)} \\ &SDA_SOURCE, \\ &SCL_SOURCE = 0.0 \text{ V} \end{split}$	-10		10	μА
C _{I/O}	Input/output capacitance (switch off)	V _{I(pp)} =1 V, 100 KHz V _{CC} =3.3 V, T=25C		5		pF
C _{I/O}	Input/output capacitance (switch on)	$V_{I(pp)}$ =1 V, 100KHz V_{CC} = 3.3 V, T= 25 ° C			10	pF
R _{ON}	Switch resistance	$I_O=3 \text{ mA}, V_O=0.4 \text{ V}$ $V_{CC}=3.3 \text{ V}$		27	40	Ω
T _{PD}	DDC_SINK to DDC_SOURCE propagation delay	Time from DDC_SINK changing state to DDC_SOURCE changing state while the pass gate is enabled. CL=10 pF RPU=1.5 K (min), 2.0 K (max)		8	15	ns
T _{SX}	Switch time from DDC_EN to the valid state on DDC_SOURCE	$C_L = 10 \text{ pF}$ $R_{PU} = 1.5 \text{ K (min)}, 2.0 \text{ K}$ (max)		8	15	ns

STHDLS101T **Maximum ratings**

5.5 **OE_ input characteristics**

Table 12. **OE_N** input characteristics

Symbol	Parameter	Comment	Min	Тур	Max	Unit
V _{IH-OE_N}	Input high level		2		VCC33	V
V _{IL-OE_N}	Input low level		0		0.8	V
I _{IN-OE_N}	Input leakage current	Measured with OE_N at VIH-OE_N max and VIL-OE_N mix			200	μΑ

5.6 **HPD** input resistor

Table 13. **HDP** input resistor

5.6 Table 13.	HPD input resistor			divis	ile	
Symbol	Parameter	Comment	Min	Тур	Max	Unit
R _{HPD}	HPD_SINK input pull-down resistor	Guarantees HPD_SINK is LOW when no display is plugged in	130 K	160 K	190 K	Ω

ESD performance 5.7

ESD performance Table 14.

Symbo	Parameter	Test condition	Min	Тур	Max	Unit
ESD	MIL STD 883 method 3015 (all pins)	Human Body Model (HBM)	-6		+6	kV
5/05 ⁽	Jete Pros					

6 Application information

6.1 Power supply sequencing

Proper power-supply sequencing is advised for all CMOS devices. It is recommended to always apply V_{CC} before applying any signals to the input/output or control pins.

6.2 Supply bypassing

Bypass each of the V_{CC} pins with 0.1 μ F and 1nF capacitors in parallel as close to the device as possible, with the smaller-valued capacitor as close to the V_{CC} pin of the device as possible.

6.3 Differential traces

The high-speed inputs and TMDS outputs are the most critical parts for the device. There are several considerations to minimize discontinuities on these transmission lines between the connectors and the device.

- (a) Maintain 100 Ω differential transmission line impedance into and out of the device.
- (b) Keep an uninterrupted ground plane below the high-speed I/Os.
- (c) Keep the ground-path vias to the device as close as possible to allow the shortest return current path.
- (d) Layout of the TMDS differential outputs should be with the shortest stubs from the connectors.

Output trace characteristics affect the performance of the STHDLS101T. Use controlled impedance traces to match trace impedance to both the transmission medium impedance and termination resistor. Run the differential traces close together to minimize the effects of the noise. Reduce skew by matching the electrical length of the traces. Avoid discontinuities in the differential trace layout. Avoid 90 degree turns and minimize the number of vias to further prevent impedance discontinuities.

7 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK[®] packages. These packages have a Lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

Obsolete Product(s).

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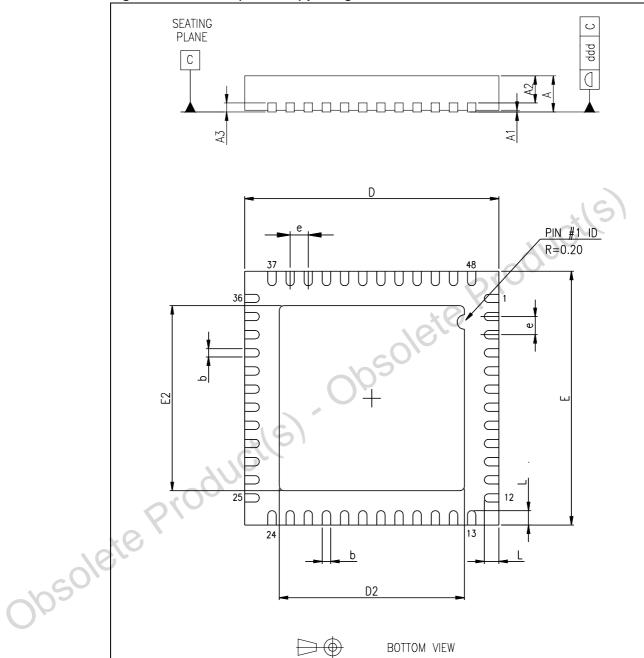


Figure 6. QFN-48 (7 x 7 mm) package outline

Table 15. QFN-48 (7 x 7 mm) package mechanical data

Symbol	Min	Тур	Max	Min	Тур	Max
Α	0.80	0.90	1.00	0.80	0.85	1.00
A1		0.02	0.05		0.01	0.05
A2		0.65	1.00		0.65	
А3		0.25			0.20	
b	0.18	0.23	0.30	0.18	0.23	0.30
D	6.85	7.00	7.15	6.90	7.00	7.10
D2	2.25	4.70	5.25	SEE EXPO	SED PAD VAF	RIATIONS
Е	6.85	7.00	7.15	6.90	7.00	7.10
E2	2.25	4.70	5.25	SEE EXPO	SED PAD VAF	RIATIONS
е	0.45	0.50	0.55	0.45	0.50	0.55
L	0.30	0.40	0.50	0.30	0.40	0.50
ddd			0.08	.0.		0.08

Figure 7. QFN-48 tape and reel information

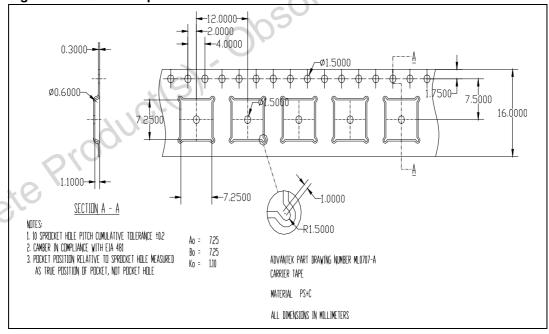


Figure 8. Reel information

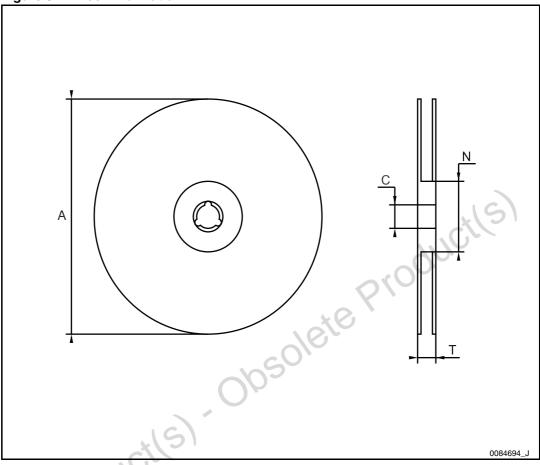


Table 16. Reel mechanical data (dimensions in mm)

O A	С	N	Т
330.2	13 ±0.25	100	16.4

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STHDLS101T Revision history

8 Revision history

Table 17. Document revision history

	Date	Revision	Changes
	30-Jun-2008	1	Initial release.
	24-Sep-2008	2	Document status promoted from preliminary data to datasheet. Modified: features section, <i>Table 2: Pin description on page 8</i> and <i>Section 4: Functional description</i> .
	01-Dec-2008	3	Updated: Features section and Chapter 5: Maximum ratings Added: Figure 3: Cable adapter on page 5, Figure 4: DP to HDMI/DVI cable adapter on page 6, Figure 8: Reel information on page 24 and Table 16: Reel mechanical data (dimensions in mm) on page 24
Obsole	te Pro	ductl	obsolete Prodes

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